MC33079

Low noise quad operational amplifier

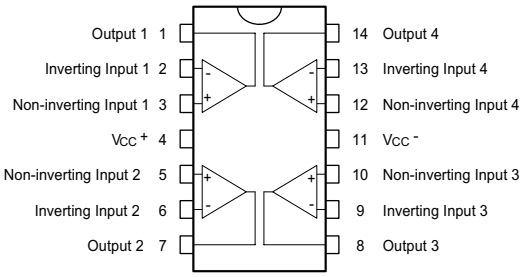
Features

- Low voltage noise: 4.5 nV/√Hz
- High gain bandwidth product: 15 MHz
- High slew rate: 7 V/µs
- Low distortion: 0.002%
- Large output voltage swing: +14.3 V/-14.6 V
- Excellent frequency stability
- ESD protection 2 kV
- Macromodel included in this specification

DIP14
(Plastic package)

SO-14
(Plastic micropackage)

Pin connections
(top view)



Description

The MC33079 is a monolithic quad operational amplifier particularly well suited for audio applications.

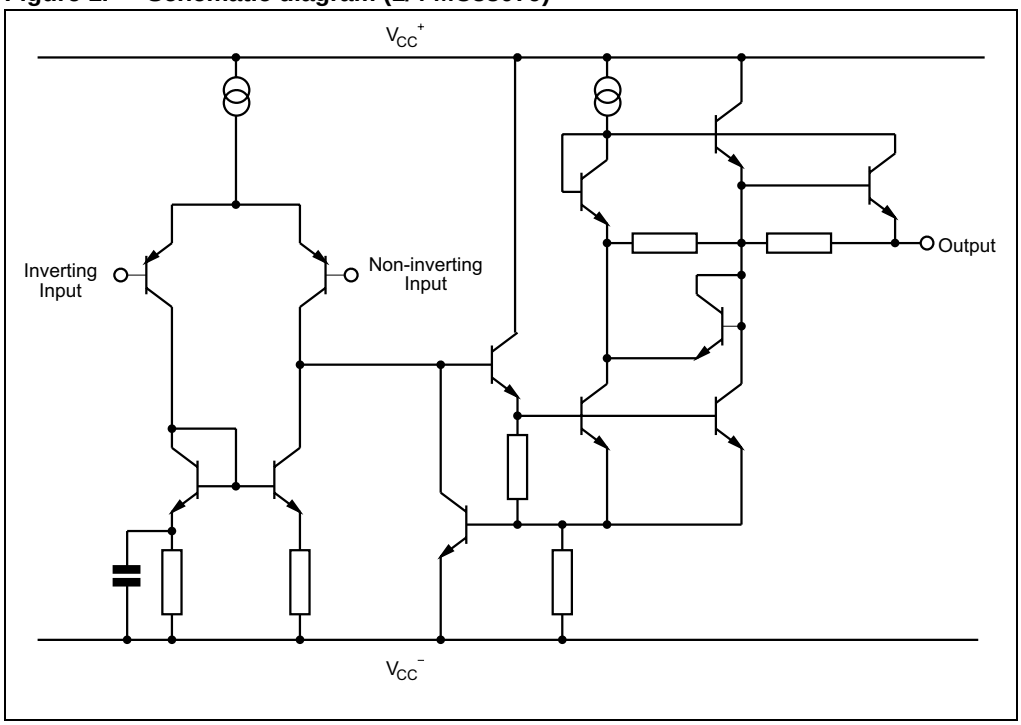
It offers low voltage noise (4.5 nV/√Hz) and high frequency performance (15 MHz gain bandwidth product, 7 V/µs slew rate).

In addition the MC33079 has a very low distortion (0.002%) and excellent phase/gain margins.

The output stage allows a large output voltage swing and symmetrical source and sink currents.

1 Schematic diagram (1/4 MC33079)

Figure 1. Schematic diagram (1/4 MC33079)



2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	±18 or +36	V
V_{id}	Differential input voltage (1)	±30	V
V_i	Input voltage (1)	±15	V
	Output short-circuit duration	Infinite	s
T_j	Junction temperature	+150	°C
T_{stg}	Storage temperature	-65 to +150	°C
R_{thja}	Thermal resistance junction to ambient (2) (3) DIP14 SO-14	 80 105	°C/W
R_{thjc}	Thermal resistance junction to case (2) (3) DIP14 SO-14	 33 31	°C/W
ESD	HBM: human body model(4)	2	kV
	MM: machine model(5)	200	V
	CDM: charged device model(6)	1.5	kV

1. Either or both input voltages must not exceed the magnitude of V_{CC}^+ or V_{CC}^-.
2. Short-circuits can cause excessive heating. Destructive dissipation can result from simultaneous short-circuits on all amplifiers.
3. R_{th} are typical values.
4. Human body model: 100 pF discharged through a 1.5 kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
5. Machine model: a 200 pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.
6. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	±2.5 to ±15	V
T_{oper}	Operating free-air temperature range	-40 to 105	°C
V_{icm}	Input common mode voltage range (ΔV_{io}= 5mV, V_o= 0V)	±13 to ±14	V

3 Electrical characteristics

Table 3. V_{CC}^+ = +15V, V_{CC}^- = -15V, T_{amb} = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage (V_o = 0V, V_{ic} = 0V) $T_{min} \le T_{amb} \le T_{max}$			2.5 3.5	mV
DV_{io}	Input offset voltage drift V_o = 0V, V_{ic} = 0V, $T_{min} \le T_{amb} \le T_{max}$		2		µV/°C
I_{io}	Input offset current (V_o = 0V, V_{ic} = 0V) $T_{min} \le T_{amb} \le T_{max}$		10	150 175	nA
I_{ib}	Input bias current (V_o = 0V, V_{ic} = 0V) $T_{min} \le T_{amb} \le T_{max}$		250	750 800	nA
A_{vd}	Large signal voltage gain (R_L = 2kΩ, V_o = ±10V) $T_{min} \le T_{amb} \le T_{max}$	90 85	100		dB
$\pm V_{opp}$	Output voltage swing (V_{id} = ±1V) R_L = 600Ω R_L = 600Ω R_L = 2.0kΩ R_L = 2.0kΩ R_L = 10kΩ R_L = 10kΩ	 13.2 13.5	 12.2 -12.7 14 -14.2 14.3 -14.6	 -13.2 -14	V
CMR	Common-mode rejection ratio (V_{ic} = ±13V)	80	100		dB
SVR	Supply voltage rejection ratio (V_{CC}^+ / V_{CC}^-= +15V / -15V to +5V / -5V)	80	105		dB
I_o	Output short-circuit current (V_{id} = ±1V, output to ground) Source Sink	 15 20	 29 37		mA
I_{CC}	Supply current (V_o = 0V, all amplifiers) $T_{min} \le T_{amb} \le T_{max}$		8	10 12	mA
SR	Slew rate (V_i = -10V to +10V, R_L = 2kΩ, C_L = 100pF, A_V = +1)	5	7		V/µs
GBP	Gain bandwidth product (R_L = 2kΩ, C_L = 100pF, f = 100kHz)	10	15		MHz
B	Unity gain bandwidth (open loop)		9		MHz
A_m	Gain margin (R_L = 2kΩ) C_L = 0pF C_L = 100pF		 -11 -6		dB
ϕm	Phase margin (R_L = 2kΩ) C_L = 0pF C_L = 100pF		 55 30		Degrees
e_n	Equivalent input noise voltage (R_S = 100Ω, f = 1kHz)		4.5		$\frac{nV}{\sqrt{Hz}}$
i_n	Equivalent input noise current (f = 1kHz)		0.5		$\frac{pA}{\sqrt{Hz}}$

Table 3. V_{CC}^+ = +15V, V_{CC}^- = -15V, T_{amb} = 25°C (unless otherwise specified) (continued)

Symbol	Parameter	Min.	Typ.	Max.	Unit
THD	Total harmonic distortion (R_L = 2kΩ, f = 20Hz to 20kHz, V_o = $3V_{rms}$, A_V = +1)		0.002		%
V_{O1}/V_{O2}	Channel separation (f = 20Hz to 20kHz)		120		dB
FPB	Full power bandwidth (V_o = $27V_{pp}$, R_L = 2kΩ, THD ≤1%)		120		kHz
Z_o	Output impedance (V_o = 0V, f = 9MHz)		37		Ω
R_i	Input resistance (V_{ic} = 0V)		175		kΩ
C_i	Input capacitance (V_{ic} = 0V)		12		pF

Figure 2. Supply current vs. supply voltage

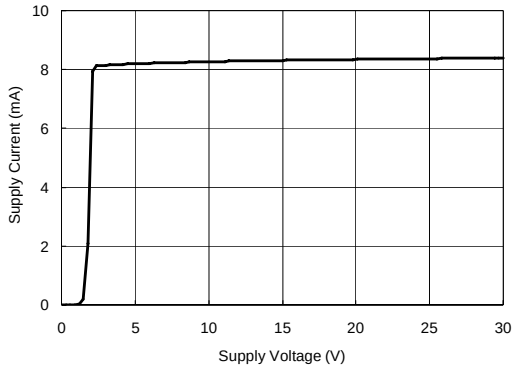


Figure 3. Output voltage vs. supply voltage

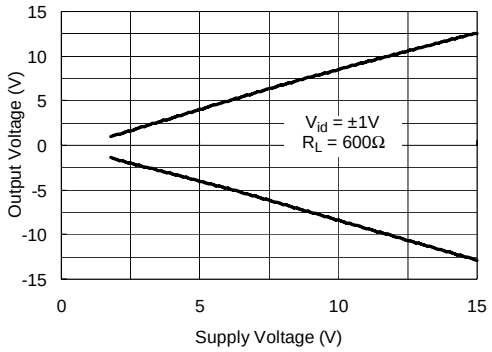


Figure 4. Equivalent input noise voltage vs. frequency

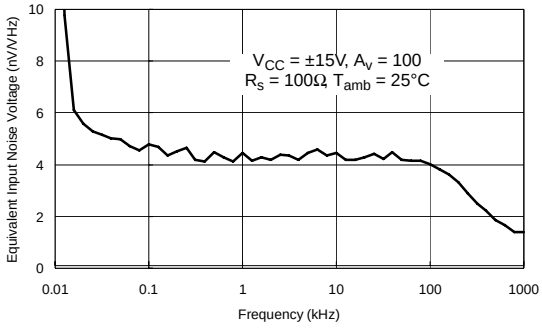


Figure 5. Output short circuit current vs. output voltage

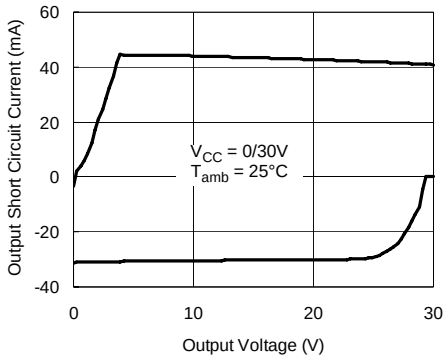


Figure 6. Output voltage vs. supply voltage

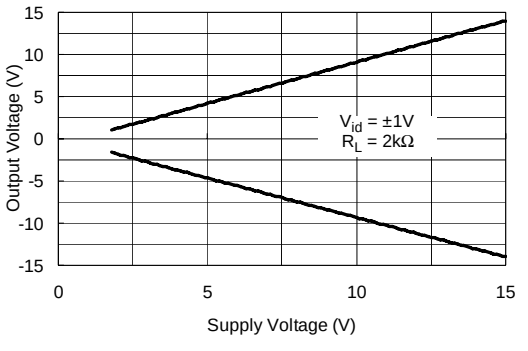


Figure 7. THD + noise vs. frequency

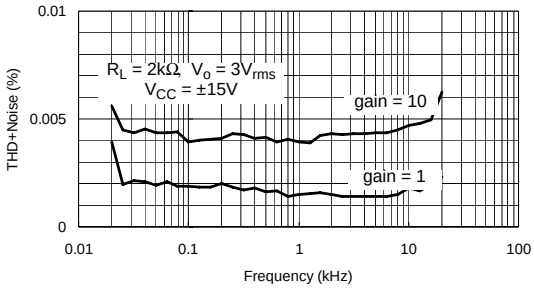


Figure 8. Voltage gain and phase vs. frequency

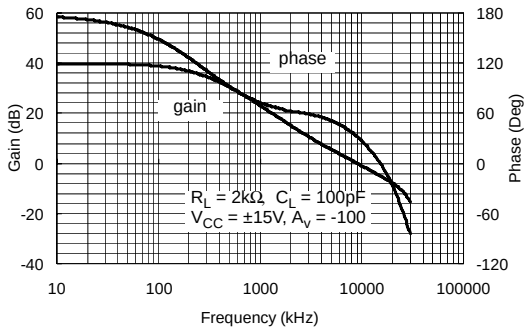
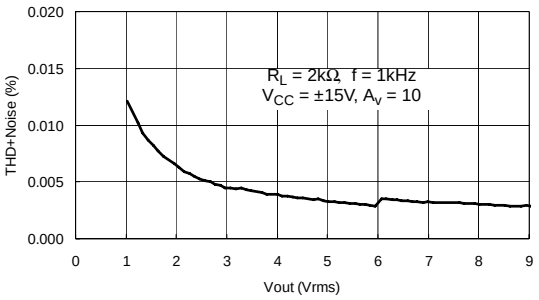


Figure 9. Total harmonic distortion vs. output voltage



4 Package information

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

4.1 DIP14 package information

Figure 10. DIP14 package mechanical drawing

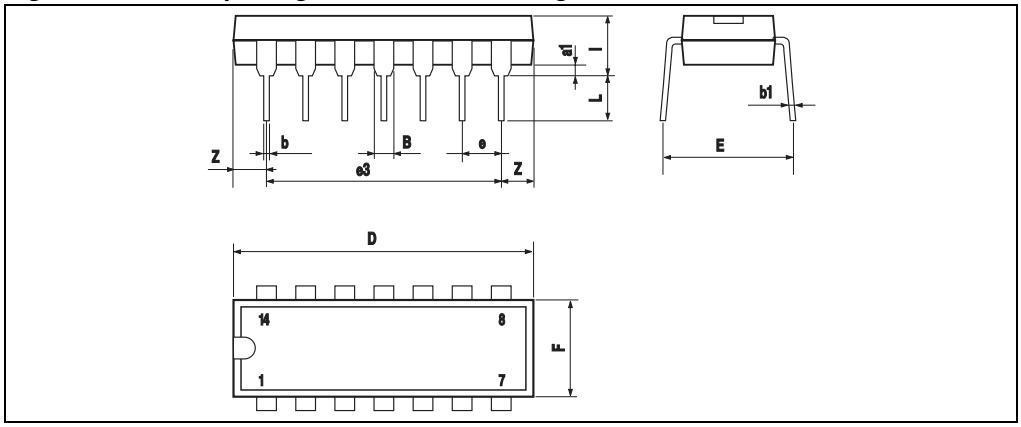


Table 4. DIP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201

Table 4. DIP14 package mechanical data

L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

4.2 SO-14 package information

Figure 11. SO-14 package mechanical drawing

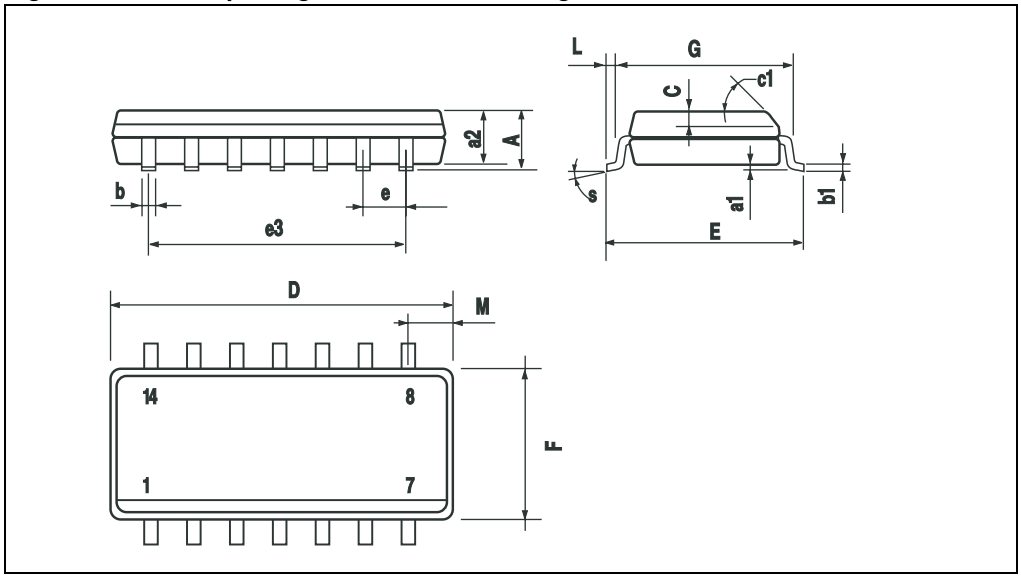


Table 5. SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157

Table 5. SO-14 package mechanical data

G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					

5 Ordering information

Table 6. Order codes

Order code	Temperature range	Package	Packaging	Marking
MC33079N	-40°C to +105°C	DIP14	Tube	MC33079N
MC33079D MC33079DT		SO-14	Tube or Tape & reel	33079
MC33079YD(1) MC33079YDT(1)	-40°C to + 105°C	SO-14 (Automotive grade)	Tube or Tape & reel	33079Y

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.

6 Revision history

Table 7. Document revision history

Date	Revision	Changes
10-Oct-2001	1	Initial release.
23-Jun-2005	2	PPAP references inserted in the datasheet. See order codes table.
21-Nov-2007	3	Added R_{thja}, R_{thjc} and ESD values in *Table 1: Absolute maximum ratings (AMR)*. Added footnote for automotive grade order codes in order codes table. Updated document format.
13-Mar-2008	4	Corrected value for ESD HBM parameter. Removed section on Macromodel.

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